

IRF9140

PD-93976E

Repetitive Avalanche and dv/dt Rated Power MOSFET Thru-Hole (TO-204AA) -100V, -18A, P-channel

Features

- Repetitive avalanche ratings
- Dynamic dv/dt rating
- Hermetically sealed
- Simple drive requirements
- ESD rating: Class 2 per MIL-STD-750, Method 1020

Product Summary

- BV_{DSS} : -100V
- I_D : -18A
- $R_{DS(on),max}$: 0.2Ω
- $Q_{G,max}$: 60nC

Potential Applications

- DC-DC converter
- Motor drives

Product Validation

Adhered to JANTX screening flow according to MIL-PRF-19500 for high-reliability applications



Description

HEXFET POWER MOSFET technology is the key to IR HIREL advanced line of power MOSFET transistors. The efficient geometry and unique processing of this latest "State of the Art" design achieves: very low on-state resistance combined with high transconductance; superior reverse energy and diode recovery dv/dt capability. The HEXFET transistors also feature all of the well-established advantages of MOSFETs such as voltage control, very fast switching and temperature stability of the electrical parameters. They are well suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers and high energy pulse circuits.

Ordering Information

Table 1 Ordering options

Part number	Package	Screening Level
IRF9140	TO-3 (TO-204AA)	COTS
IRF9140SCX	TO-3 (TO-204AA)	JANTX

Table of contents**Table of contents**

Features	1
Potential Applications.....	1
Product Validation.....	1
Description	1
Table of contents.....	2
1 Absolute Maximum Ratings	3
2 Device Characteristics	4
2.1 Electrical Characteristics	4
2.2 Source-Drain Diode Ratings and Characteristics	5
2.3 Thermal Characteristics	5
3 Electrical Characteristics Curves.....	6
4 Test Circuits	9
5 Package Outline	10
Revision history.....	11

Absolute Maximum Ratings**1 Absolute Maximum Ratings****Table 2 Absolute Maximum Ratings**

Symbol	Parameter	Value	Unit
I_{D1} @ $V_{GS} = -10V$, $T_c = 25^\circ C$	Continuous Drain Current	-18	A
I_{D2} @ $V_{GS} = -10V$, $T_c = 100^\circ C$	Continuous Drain Current	-11	A
I_{DM} @ $T_c = 25^\circ C$	Pulsed Drain Current ¹	-72	A
P_D @ $T_c = 25^\circ C$	Maximum Power Dissipation	125	W
	Linear Derating Factor	1.0	$W/^\circ C$
V_{GS}	Gate-to-Source Voltage	± 20	V
E_{AS}	Single Pulse Avalanche Energy ²	500	mJ
I_{AR}	Avalanche Current ¹	-18	A
E_{AR}	Repetitive Avalanche Energy ¹	12.5	mJ
dv/dt	Peak Diode Reverse Recovery ³	-5.5	V/ns
T_J T_{STG}	Operating Junction and Storage Temperature Range	-55 to +150	$^\circ C$
	Lead Temperature	300 (0.063 in. (1.6mm) from case for 10s)	
	Weight	11.5 (Typical)	g

¹ Repetitive Rating; Pulse width limited by maximum junction temperature.² $V_{DD} = -25V$, starting $T_J = 25^\circ C$, $L = 3.09mH$, Peak $I_L = -18A$, $V_{GS} = -10V$ ³ $I_{SD} \leq -18A$, $di/dt \leq -100A/\mu s$, $V_{DD} \leq -100V$, $T_J \leq 150^\circ C$

Device Characteristics

2 Device Characteristics**2.1 Electrical Characteristics****Table 3 Static and Dynamic Electrical Characteristics @ $T_j = 25^\circ\text{C}$ (Unless Otherwise Specified)**

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions
BV_{DSS}	Drain-to-Source Breakdown Voltage	-100	—	—	V	$\text{V}_{\text{GS}} = 0\text{V}, \text{I}_D = -1.0\text{mA}$
$\Delta \text{BV}_{\text{DSS}}/\Delta T_j$	Breakdown Voltage Temp. Coefficient	—	-0.087	—	V/ $^\circ\text{C}$	Reference to 25°C , $\text{I}_D = -1.0\text{mA}$
$R_{\text{DS}(\text{on})}$	Static Drain-to-Source On-State Resistance	—	—	0.2	Ω	$\text{V}_{\text{GS}} = -10\text{V}, \text{I}_{\text{D2}} = -11\text{A}^1$
		—	—	0.23		$\text{V}_{\text{GS}} = -10\text{V}, \text{I}_{\text{D2}} = -18\text{A}^1$
$\text{V}_{\text{GS}(\text{th})}$	Gate Threshold Voltage	-2.0	—	-4.0	V	$\text{V}_{\text{DS}} = \text{V}_{\text{GS}}, \text{I}_D = -250\mu\text{A}$
G_{fs}	Forward Transconductance	6.2	—	—	S	$\text{V}_{\text{DS}} = -15\text{V}, \text{I}_{\text{D2}} = -11\text{A}^1$
I_{DSS}	Zero Gate Voltage Drain Current	—	—	-25	μA	$\text{V}_{\text{DS}} = -80\text{V}, \text{V}_{\text{GS}} = 0\text{V}$
		—	—	-250		$\text{V}_{\text{DS}} = -80\text{V}, \text{V}_{\text{GS}} = 0\text{V}, T_j = 125^\circ\text{C}$
I_{GSS}	Gate-to-Source Leakage Forward	—	—	-100	nA	$\text{V}_{\text{GS}} = -20\text{V}$
	Gate-to-Source Leakage Reverse	—	—	100		$\text{V}_{\text{GS}} = 20\text{V}$
Q_G	Total Gate Charge	31	—	60	nC	$\text{I}_{\text{D1}} = -18\text{A}$ $\text{V}_{\text{DS}} = -50\text{V}$ $\text{V}_{\text{GS}} = -10\text{V}$
Q_{GS}	Gate-to-Source Charge	3.7	—	13		
Q_{GD}	Gate-to-Drain ('Miller') Charge	7.0	—	35.2		
$t_{\text{d}(\text{on})}$	Turn-On Delay Time	—	—	35	ns	$\text{I}_{\text{D1}} = -18\text{A}^{**}$ $\text{V}_{\text{DD}} = -50\text{V}$ $\text{R}_G = 9.1\Omega$ $\text{V}_{\text{GS}} = -10\text{V}$
t_r	Rise Time	—	—	200		
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time	—	—	85		
t_f	Fall Time	—	—	65		
$L_s + L_D$	Total Inductance	—	6.1	—	nH	Measured from Drain lead (6mm / 0.25 in from package) to Source lead (6mm / 0.25 in from package)
C_{iss}	Input Capacitance	—	1400	—	pF	$\text{V}_{\text{GS}} = 0\text{V}$ $\text{V}_{\text{DS}} = -25\text{V}$ $f = 1.0\text{MHz}$
C_{oss}	Output Capacitance	—	600	—		
C_{rss}	Reverse Transfer Capacitance	—	200	—		

** Switching speed maximum limits are based on manufacturing test equipment and capability.

¹ Pulse width $\leq 300\ \mu\text{s}$; Duty Cycle $\leq 2\%$

Device Characteristics

2.2 Source-Drain Diode Ratings and Characteristics

Table 4 Source-Drain Diode Characteristics

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions
I_S	Continuous Source Current (Body Diode)	—	—	-18	A	
I_{SM}	Pulsed Source Current (Body Diode) ¹	—	—	-72	A	
V_{SD}	Diode Forward Voltage	—	—	-5.0	V	$T_J = 25^\circ\text{C}$, $I_S = -18\text{A}$, $V_{GS} = 0\text{V}$ ²
t_{rr}	Reverse Recovery Time	—	170	280	ns	$T_J = 25^\circ\text{C}$, $I_F = -18\text{A}$, $V_{DD} \leq -50\text{V}$
Q_{rr}	Reverse Recovery Charge	—	2.4	—	μC	$\frac{di}{dt} = -100\text{A}/\mu\text{s}$ ²
t_{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by L_S+L_D)				

2.3 Thermal Characteristics

Table 5 Thermal Resistance

Symbol	Parameter	Min.	Typ.	Max.	Unit
$R_{\theta JC}$	Junction-to-Case	—	—	1.0	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Junction-to-Ambient (Typical socket mount)	—	—	30	

¹ Repetitive Rating; Pulse width limited by maximum junction temperature.² Pulse width $\leq 300\ \mu\text{s}$; Duty Cycle $\leq 2\%$

Electrical Characteristics Curves

3 Electrical Characteristics Curves

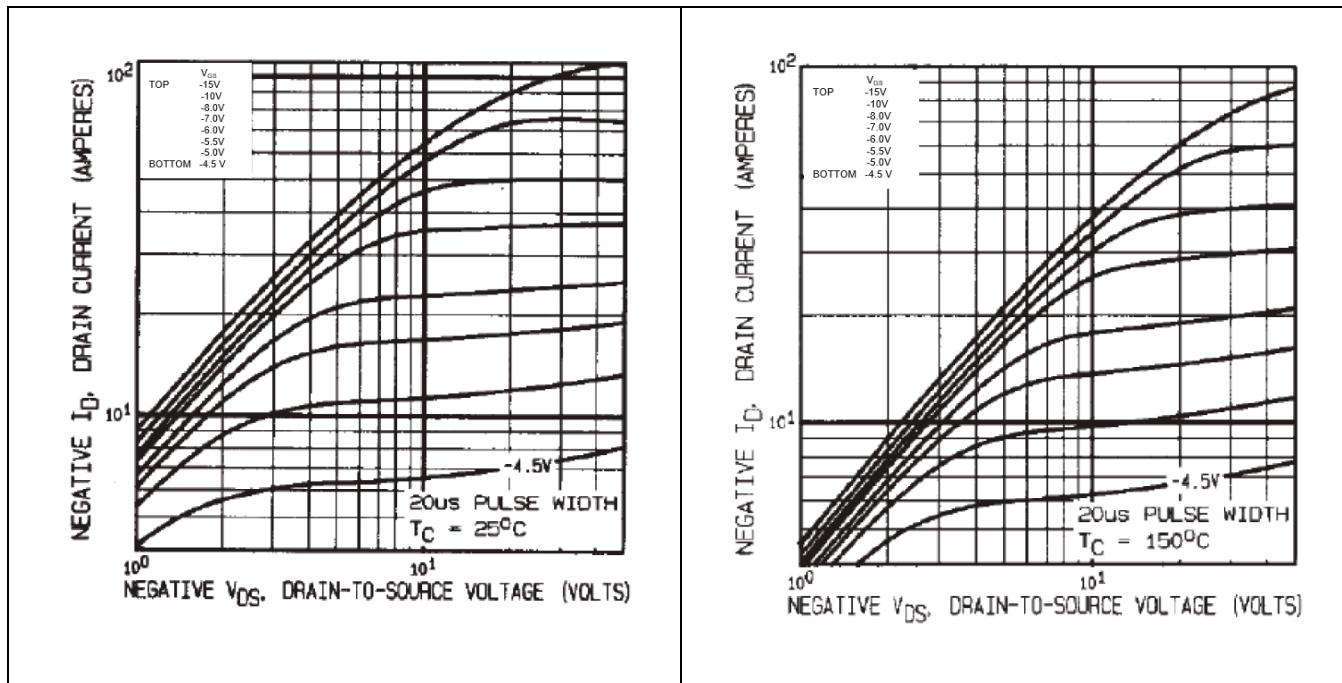


Figure 1 Typical Output Characteristics

Figure 2 Typical Output Characteristics

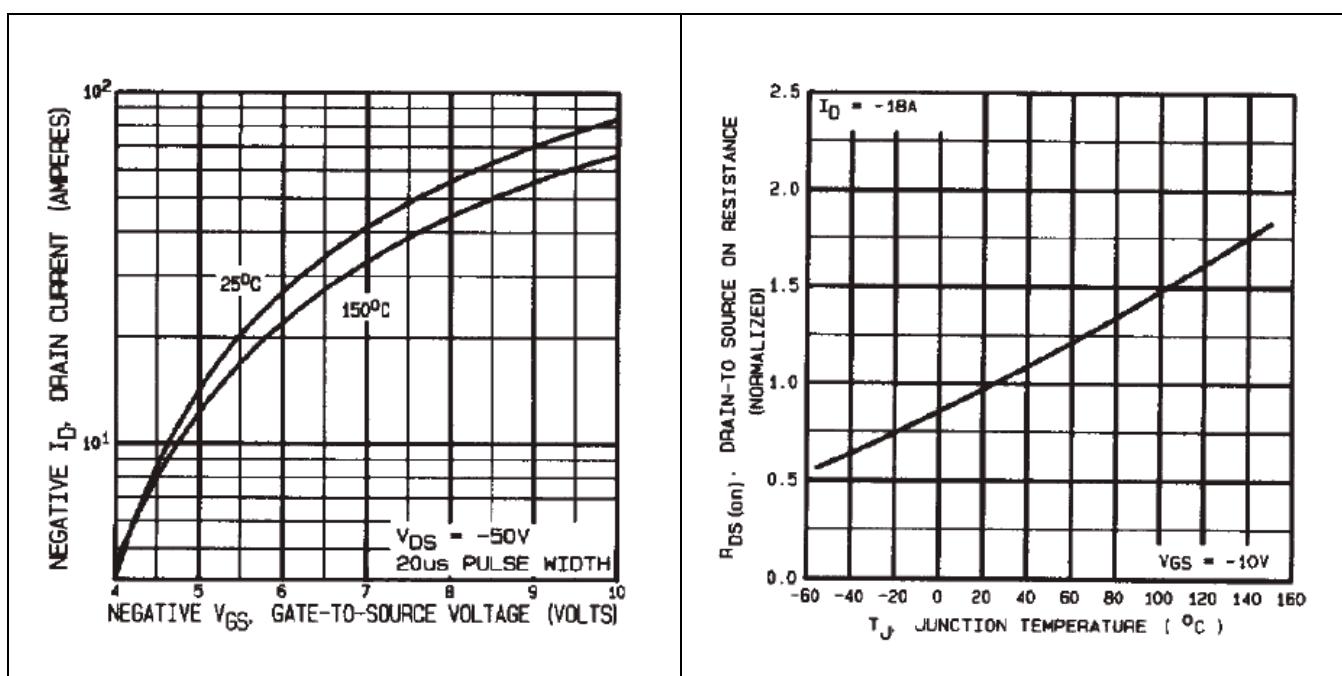
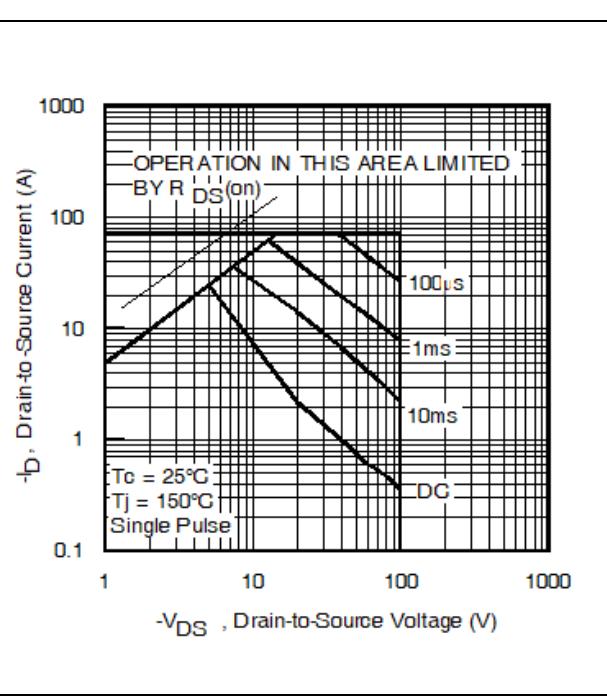
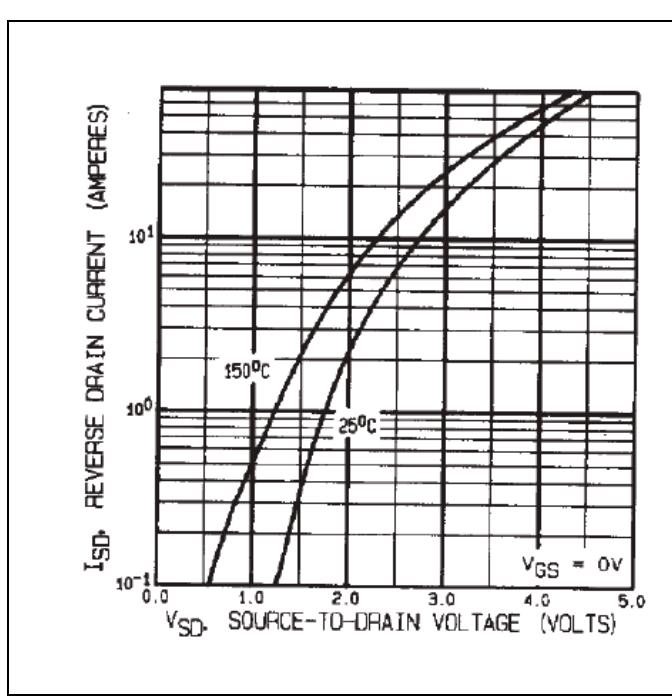
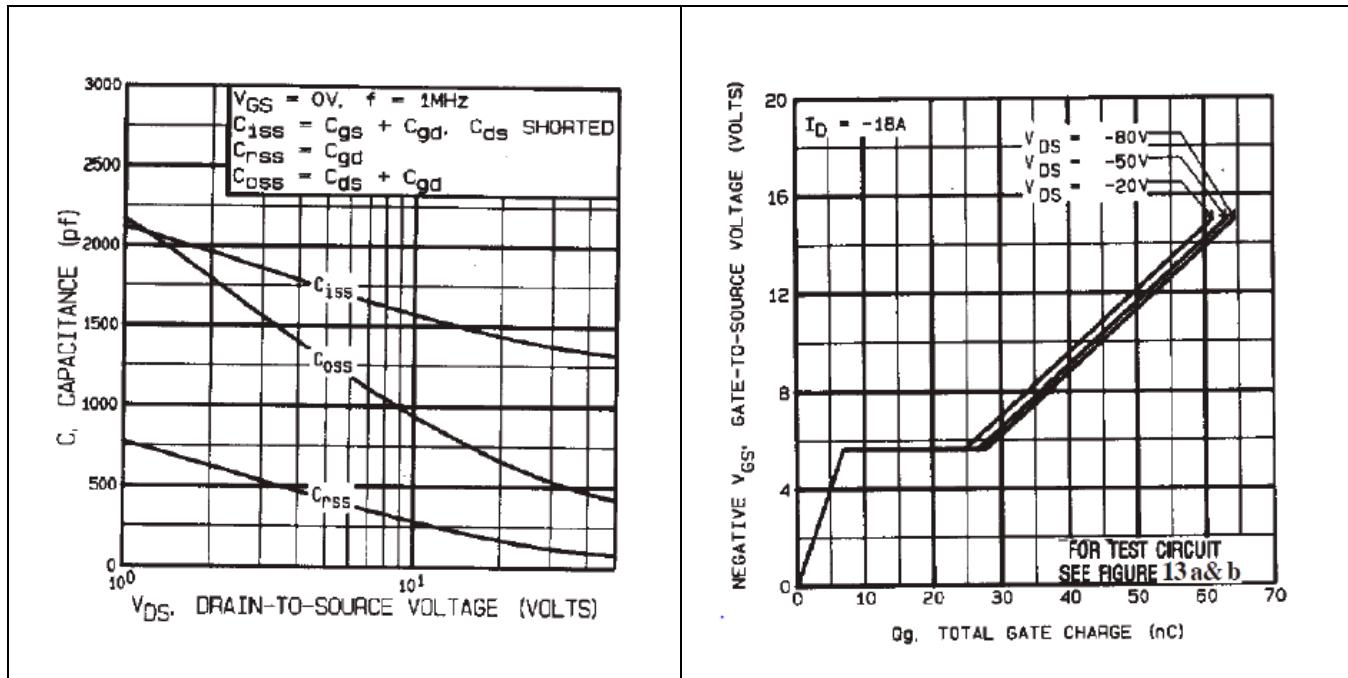


Figure 3 Typical Transfer Characteristics

Figure 4 Normalized On-Resistance Vs. Temperature

Electrical Characteristics Curves



Electrical Characteristics Curves

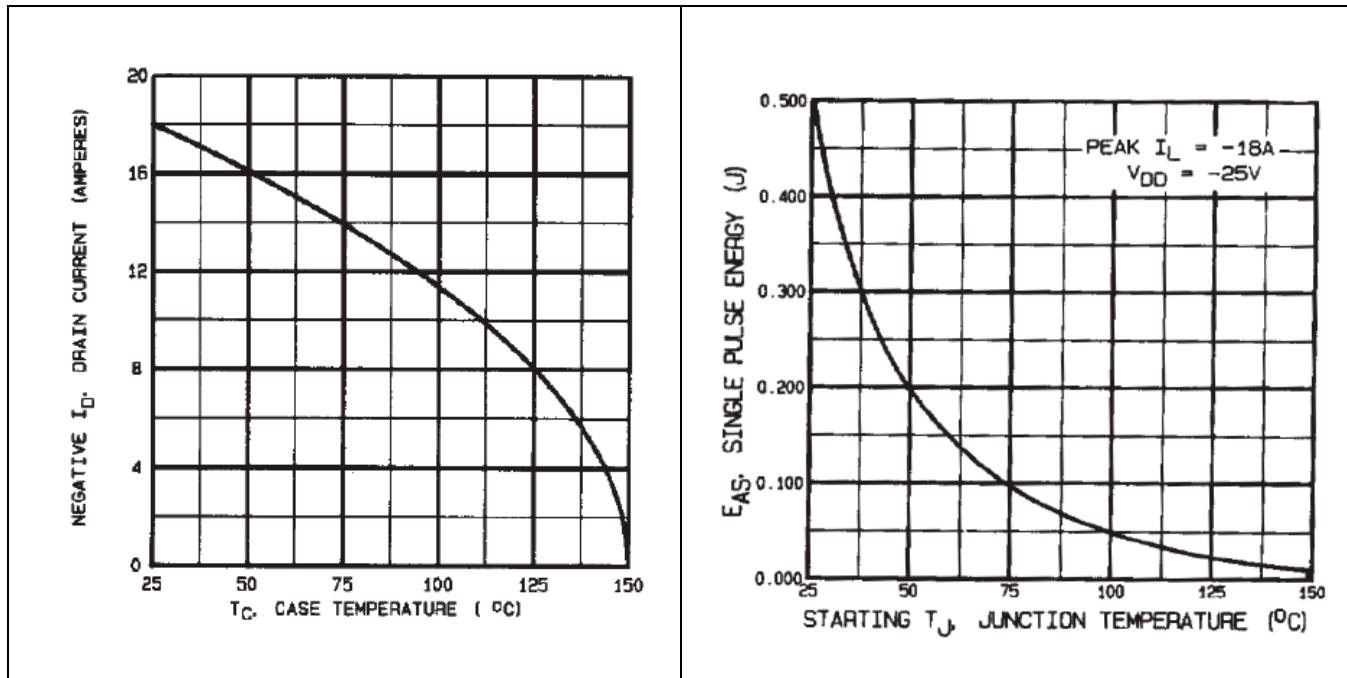


Figure 9 Maximum Drain Current Vs. Case Temperature

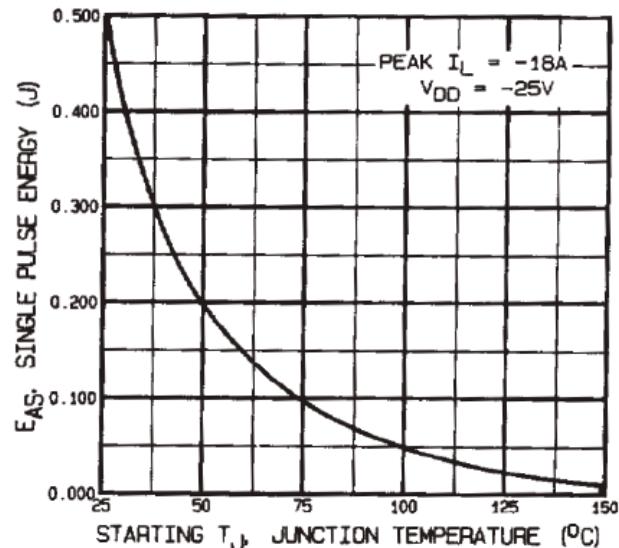
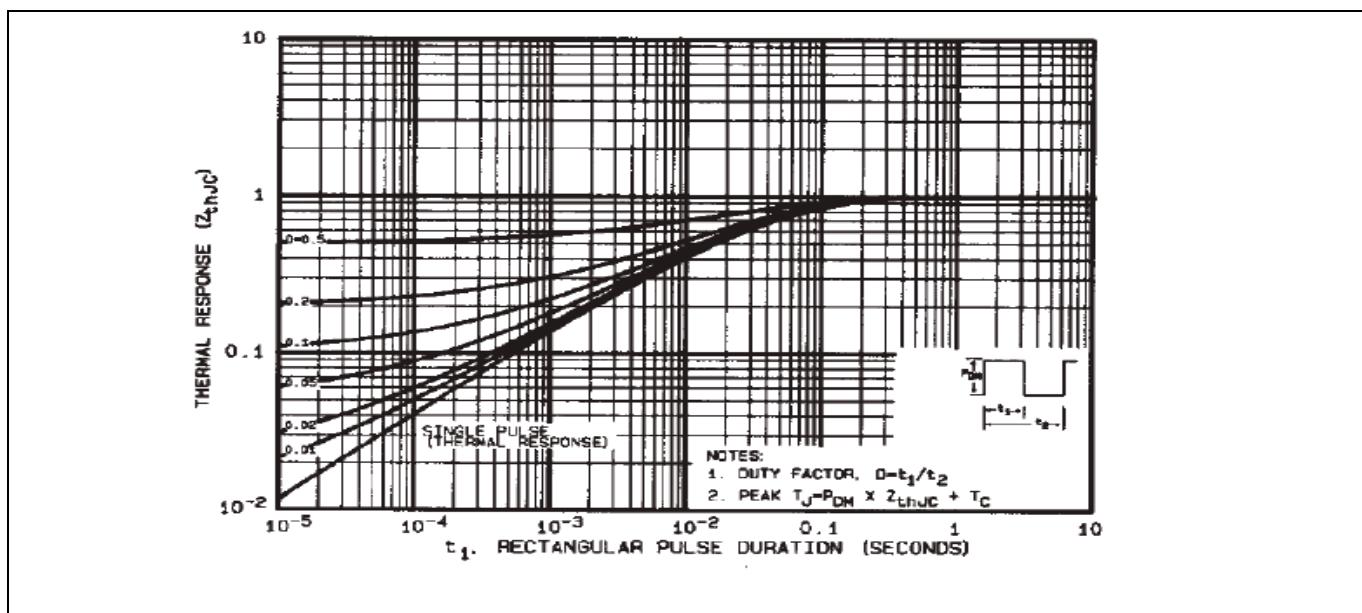


Figure 10 Maximum Avalanche Energy Vs. Junction Temperature



Test Circuits

4 Test Circuits

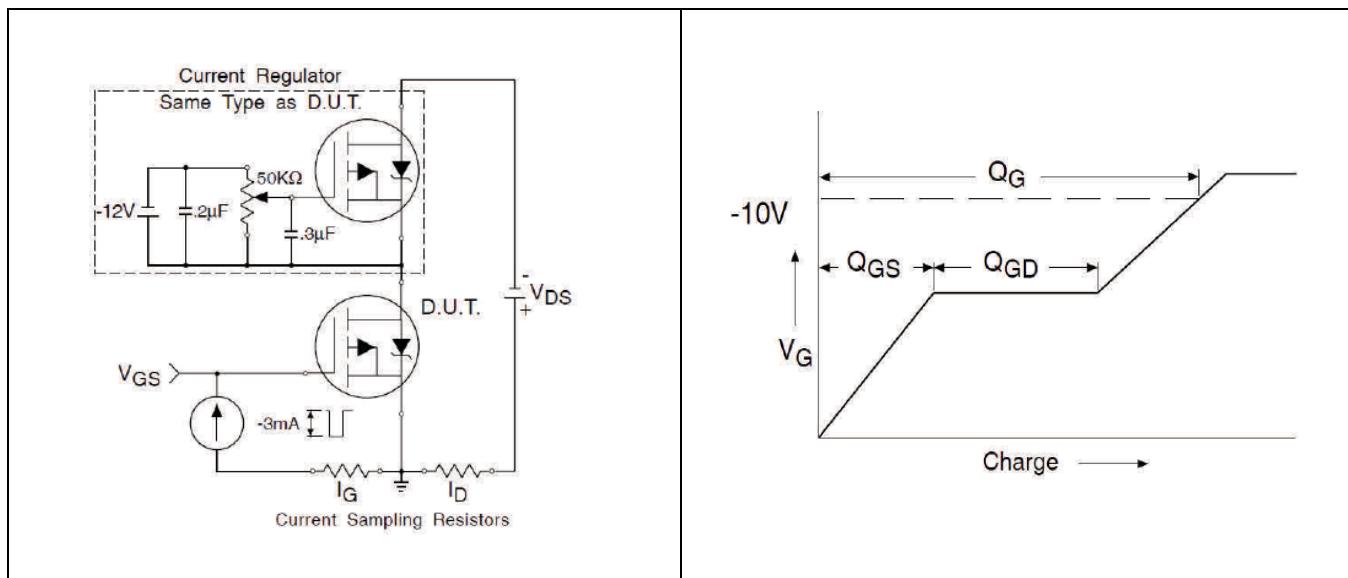


Figure 12 Gate Charge Test Circuit

Figure 13 Gate Charge Waveform

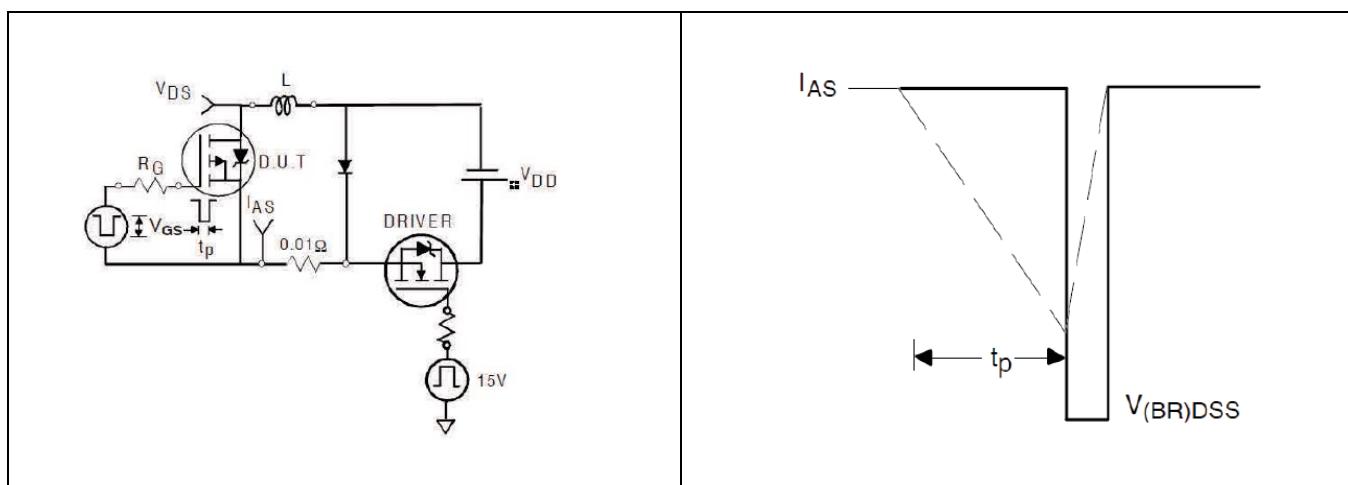


Figure 14 Unclamped Inductive Test Circuit

Figure 15 Unclamped Inductive Waveform

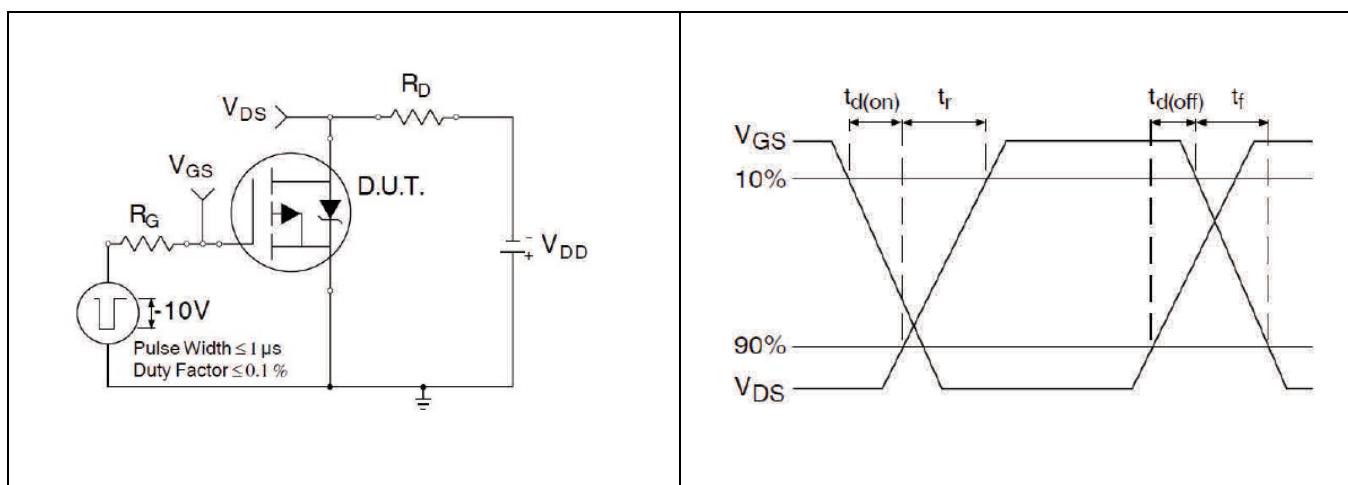


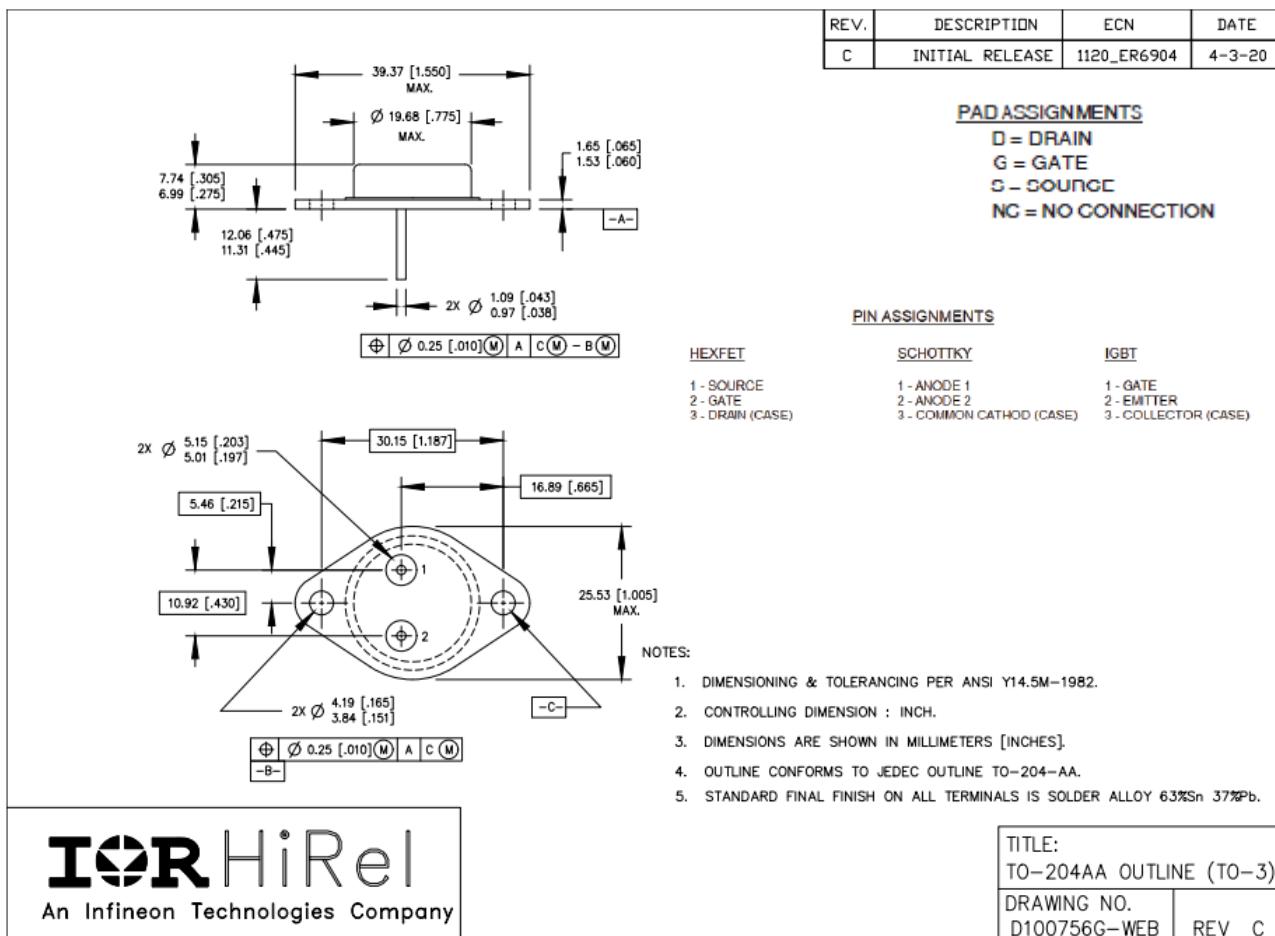
Figure 16 Switching Time Test Circuit

Figure 17 Switching Time Waveforms

Package Outline

5 Package Outline

Note: For the most updated package outline, please see the website: [TO-3 \(TO-204AA\)](#)



Revision history

Revision history

Document version	Date of release	Description of changes
	01/26/2001	Datasheet (PD-93976A)
Rev B	09/22/2003	Updated based on ECN-11069
Rev C	07/24/2019	Updated based on ECN-1120_06844
Rev D	01/09/2023	Updated based on ECN-1120_09252
Rev E	12/06/2024	Updated based on ECN-1120_10102

Trademarks

All referenced product or service names and trademarks are the property of their respective owners.

Edition 2024-12-06

Published by

**International Rectifier HiRel Products,
Inc.**

**An Infineon Technologies company
El Segundo, California 90245 USA**

**© 2024 Infineon Technologies AG.
All Rights Reserved.**

**Do you have a question about this
document?**

Email: erratum@infineon.com

Document reference

IMPORTANT NOTICE

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

For further information on the product, technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies office (www.infineon.com).

WARNINGS

Due to technical requirements components may contain dangerous substances. For information on the types in question please contact your nearest International Rectifier HiRel Products, Inc., an Infineon Technologies company, office.

International Rectifier HiRel Components may only be used in life-support devices or systems with the expressed written approval of International Rectifier HiRel Products, Inc., an Infineon Technologies company, if failure of such components can reasonably be expected to cause the failure of that life-support device or system, or to affect the safety and effectiveness of that device or system.

Life support devices or systems are intended to be implanted in the human body, or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.